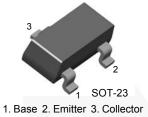


November 2014

BC817 / BC818 NPN Epitaxial Silicon Transistor

Features

- · Switching and Amplifier Applications
- · Suitable for AF-Driver Stages and Low Power Output Stages
- · Complement to BC807 / BC808



Ordering Information(1)

Part Number	Marking	Package	Packing Method	
BC81716MTF	8FA	SOT-23 3L	Tape and Reel	
BC81725MTF	8FB	SOT-23 3L	Tape and Reel	
BC81740MTF	8FC	SOT-23 3L	Tape and Reel	
BC81816MTF	8GA	SOT-23 3L	Tape and Reel	
BC81825MTF	8GB	SOT-23 3L	Tape and Reel	
BC81840MTF	8GC	SOT-23 3L	Tape and Reel	

Note:

1. Affix "-16,-25,-40" means h_{FE} classification. Affix "-M" means the matte type package. Affix "-TF" means the tape and reel type packing.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter		Value	Unit
V _{CBO} Collector-Base Voltag	Callagter Page Voltage	BC817	50	V
	Collector-base voltage	BC818	30	
V _{CEO} Colle	Callagter Emitter Voltage	BC817	45	V
	Collector-Emitter Voltage	BC818	25	V
V _{EBO}	Emitter-Base Voltage	5	V	
I _C	Collector Current (DC)		800	mA
TJ	Junction Temperature	150	°C	
T _{STG}	Storage Temperature	-65 to +150	°C	

1

Thermal Characteristics(1)

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
D	Power Dissipation	310	mW
P _D	Derate Above 25°C	2.48	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	403	°C/W

Note:

1. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics(2)

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit
BV _{CEO}	Collector-Emitter Breakdown Voltage	BC817	- 10 m	45			V
		BC818	$I_C = 10 \text{ mA}, I_B = 0$	25			
BV _{CES} Collector-Emitter Breakdown Voltage	Collector-Emitter Breakdown	BC817	$I_{\rm C}$ = 0.1 mA, $V_{\rm BE}$ = 0	50			V
	Voltage	BC818		30			
BV _{EBO}	Emitter-Base Breakdown Voltage		I _E = 0.1 mA, I _C = 0	5			V
I _{CES}	Collector Cut-Off Current		V _{CE} = 25 V, V _{BE} = 0			100	nA
I _{EBO}	Emitter Cut-Off Current		$V_{EB} = 4 \text{ V}, I_{C} = 0$			100	nA
h _{FE1}	h _{FE1} DC Current Gain		$V_{CE} = 1 \text{ V, } I_{C} = 100 \text{ mA}$	100		630	
h _{FE2}			$V_{CE} = 1 \text{ V, } I_{C} = 300 \text{ mA}$	60			
V _{CE} (sat)) Collector-Emitter Saturation Voltage		I _C = 500 mA, I _B = 50 mA			0.7	V
V _{BE} (on)) Base-Emitter On Voltage		$V_{CE} = 1 \text{ V, } I_{C} = 300 \text{ mA}$			1.2	V
f _T	Current Gain Bandwidth Product		V _{CE} = 5 V, I _C = 10 mA, f = 50 MHz		100		MHz
C _{ob}	Output Capacitance		V _{CB} = 10 V, f = 1 MHz			12	pF

Note:

2. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2%

h_{FE} Classification

Classification	16	25	40
h _{FE1}	100 ~ 250	160 ~ 400	250 ~ 630
h _{FE2}	60 ~	100 ~	170 ~

Typical Performance Characteristics

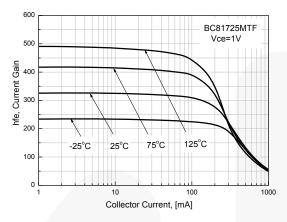


Figure 1. DC Current Gain

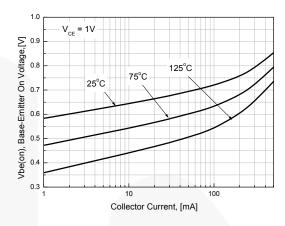


Figure 2. Base-Emitter On Voltage

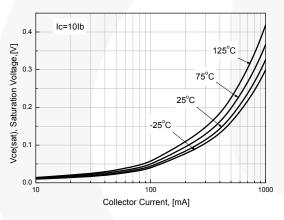


Figure 3. Collector-Emitter Saturation Voltage

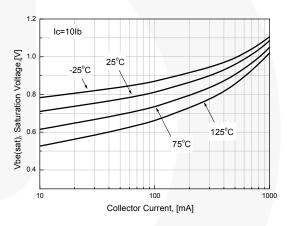


Figure 4. Base-Emitter Saturation Voltage

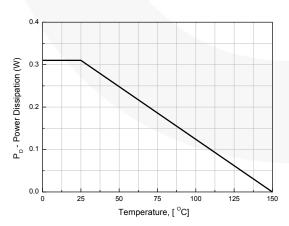
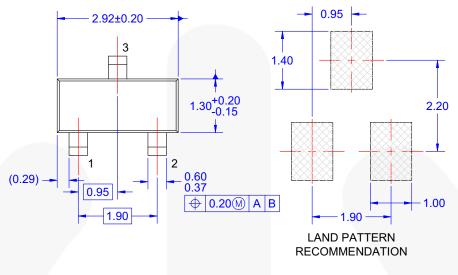
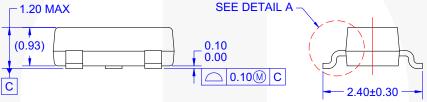
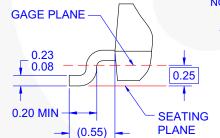


Figure 5. Power Dissipation vs Ambient Temperature

Physical Dimensions







- NOTES: UNLESS OTHERWISE SPECIFIED
 - A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.
 - B) ALL DIMENSIONS ARE IN MILLIMETERS.
 - C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
 - D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M 1994.
- SEATING E) DRAWING FILE NAME: MA03DREV10



Figure 6. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

 AccuPower™
 F-PFS™

 Awinda®
 FRFET®

 AX-CAP®∗
 Global Power Resource

 Stock
 Stock

BitSiC™ GreenBridge™ Build it Now™ Green FPS™

Current Transfer Logic™ ISOPLANAR™
DEUXPEED® Making Small St

DEUXPEED[®] Making Small Speakers Sound Louder
Dual Cool™ and Better™

EcoSPARK® MegaBuck™
EfficientMax™ MICROCOUPLER™
ESBC™ MicroFET™
MicroPak™

MicroPak2™ Fairchild® MillerDrive™ Fairchild Semiconductor® MotionMax™ FACT Quiet Series™ MotionGrid® FACT[®] FAST® MTi[®] MTx® FastvCore™ MVN® FFTBench™ mWSaver® **FPS™**

OptoHiT™ OPTOLOGIC[®] OPTOPLANAR®

® PowerTrench® PowerXS™

Programmable Active Droop™

QFET[®]
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

Solutions for Yo SPM® STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-8 SupreMOS® SyncFET™ Sync-Lock™ SYSTEM GENERAL®

TinyBoost®
TinyBuck®
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
TranSiC™

TriFault Detect™
TRUECURRENT®*

µSerDes™

SerDes"
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™
Xsens™

仙童™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT http://www.fairchildsemi.com, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OF CIRCUIT DESCRIBED HEREIN, NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 172

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor:

BC81825MTF BC81816MTF BC81840MTF BC81840